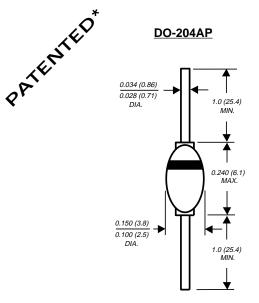
GI1001 THRU GI1004

GLASS PASSIVATED FAST EFFICIENT RECTIFIER

Reverse Voltage - 50 to 200 Volts

Forward Current - 1.0 Ampere



Dimensions in inches and (millimeters)

FEATURES

- ♦ High temperature metallurgically bonded construction
- ♦ Glass passivated cavity-free junction
- ◆ Superfast recovery time for high efficiency
- Low forward voltage, high current capability
- ◆ Capable of meeting environmental standards of MIL-S-19500
- ♦ Hermetically sealed package
- ◆ Low leakage current
- ♦ High surge capability
- ◆ High temperature soldering guaranteed: 350°C/10 seconds, 0.375" (9.5mm) lead length, 5 lbs. (2.3kg) tension

MECHANICAL DATA

Case: JEDEC DO-204AP solid glass body

Terminals: Plated axial leads, solderable per MIL-STD-750,

Method 2026

Polarity: Color band denotes cathode end

Mounting Position: Any Weight: 0.02 ounce, 0.56 gram

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

	SYMBOLS	GI1001	GI1002	GI1003	GI1004	UNITS
Maximum repetitive peak reverse voltage	Vrrm	50	100	150	200	Volts
Maximum RMS voltage	VRMS	35	70	105	140	Volts
Maximum DC blocking voltage	VDC	50	100	150	200	Volts
Maximum average forward rectified current 0.375" (9.5mm) lead length at T _L =75°C	I(AV)	1.0				Amp
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) at T _L =75°C	IFSM	30.0				Amps
Maximum instantaneous forward voltage at 1.0A	VF	0.975			Volts	
Maximum DC reverse current Ta=25°C at rated DC blocking voltage Ta=100°C	lR	2.0 50.0			μА	
Maximum reverse recovery time (NOTE 1)	t _{rr}	25.0			ns	
Typical junction capacitance (NOTE 2)	CJ	45.0			pF	
Typical thermal resistance (NOTE 3) (NOTE 4)	Roja Rojl	65.0 20.0			°C/W	
Operating junction and storage temperature range	TJ, TSTG		-65 to +175			°C

NOTES:

- (1) Reverse recovery test conditions: IF=0.5A, IR=1.0A, Irr=0.25A
- (2) Measured at 1.0 MHz and applied reverse voltage of 4.0 Volts
- (3) Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length and mounted on P.C.B. with 0.5 x 0.5" (12 x 12mm)
- (4) Thermal resistance from junction to lead at 0.375" (9.5mm) lead length with both leads attached to heatsinks



^{*} Brazed lead assembly is covered by Patent No. 3,930,30

RATINGS AND CHARACTERISTIC CURVES GI1001 THRU GI1004

FIG. 1 - MAXIMUM FORWARD CURRENT **DERATING CURVE** 1.5 0.8 x 0.8 x.04" THICK COPPER HEATSINK (20 x 20 x 1.0mm) AVERAGE FORWARD RECTIFIED CURRENT, AMPERES 1.0 RESISTIVE OR INDUCTIVE LOAD 0.375" (9.5mm) 0.5 0 25 50 75 100 125 150 LEAD TEMPERATURE, °C

